

Low Distortion 1.5 Watt Audio Power Amplifier

SSM2211*

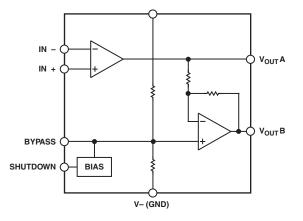
FEATURES

1.5 W Output¹ Differential (BTL²) Output Single-Supply Operation: 2.7 V to 5.5 V Functions Down to 1.75 V Wide Bandwidth: 4 MHz Highly Stable, Phase Margin: >80 Degrees Low Distortion: 0.2% THD @ 1 W Output Excellent Power Supply Rejection

APPLICATIONS

Portable Computers Personal Wireless Communicators Hands-Free Telephones Speakerphones Intercoms Musical Toys and Speaking Games

FUNCTIONAL BLOCK DIAGRAM



GENERAL DESCRIPTION

The SSM2211 is a high-performance audio amplifier that delivers 1 W RMS of low distortion audio power into a bridge-connected 8 Ω speaker load, (or 1.5 W RMS into 4 Ω load). It operates over a wide temperature range and is specified for single-supply voltages between 2.7 V and 5.5 V. When operating from batteries, it will continue to operate down to 1.75 V. This makes the SSM2211 the best choice for unregulated applications such as toys and games. Featuring a 4 MHz bandwidth and distortion below 0.2 % THD @ 1 W, superior performance is delivered at higher power or lower speaker load impedance than competitive units.

The low differential dc output voltage results in negligible losses in the speaker winding, and makes high value dc blocking capacitors unnecessary. Battery life is extended by using the Shutdown mode, which reduces quiescent current drain to typically 100 nA. The SSM2211 is designed to operate over the -20° C to $+85^{\circ}$ C temperature range. The SSM2211 is available in SO-8 and LFCSP (Lead Frame Chip Scale Package) surface mount packages. The SO-8 features the patented Thermal Coastline lead frame (see Figure 12). The advanced mechanical packaging of the SSM2211 ensures lower chip temperature and enhanced performance relative to standard packaging options. DIP samples are available; you should request a special quotation on production quantities. An evaluation board is available upon request of your local Analog Device sales office.

Applications include personal portable computers, hands-free telephones and transceivers, talking toys, intercom systems and other low voltage audio systems requiring 1 W output power.

*Protected by U.S. Patent No. 5,519,576

NOTES ¹1.5 W @ 4 Ω , 25°C ambient, <1% THD, 5 V supply, 4 layer PCB. ²Bridge Tied Load

REV. A

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SSM2211-SPECIFICATIONS

ELECTRICAL CHARACTERISTICS ($V_s = 5.0 \text{ V}$, $T_A = 25^{\circ}\text{C}$, $R_L = 8 \Omega$, $C_B = 0.1 \mu$ F, $V_{CM} = V_D/2$, unless otherwise noted.)

Parameter	Symbol	Conditions	Min Typ Max		Max	Unit	
GENERAL CHARACTERISTICS Differential Output Offset Voltage Output Impedance	V _{OOS} Z _{OUT}	$A_{\rm VD}$ = 2		4 0.1	50	mV Ω	
SHUTDOWN CONTROL Input Voltage High Input Voltage Low	$V_{\rm IH} \ V_{\rm IL}$	$I_{SY} = < 100 \ \mu A$ $I_{SY} = Normal$	3.0		1.3	V V	
POWER SUPPLY Power Supply Rejection Ratio Supply Current Supply Current, Shutdown Mode	PSRR I _{SY} I _{SD}	$V_{S} = 4.75 V \text{ to } 5.25 V$ $V_{O1} = V_{O2} = 2.5 V$ Pin 1 = V _{DD} , See TPC 29		66 9.5 100		dB mA nA	
DYNAMIC PERFORMANCE Gain Bandwidth Phase Margin	GBP Ø ⁰			4 86		MHz Degrees	
AUDIO PERFORMANCE Total Harmonic Distortion Total Harmonic Distortion Voltage Noise Density	THD + N THD + N e _n	P = 0.5 W into 8 Ω , f = 1 kHz P = 1.0 W into 8 Ω , f = 1 kHz f = 1 kHz		0.15 0.2 85		% % nV \sqrt{Hz}	

ELECTRICAL CHARACTERISTICS ($V_s = 3.3 V$, $T_A = 25^{\circ}$ C, $R_L = 8 \Omega$, $C_B = 0.1 \mu$ F, $V_{CM} = V_D/2$, unless otherwise noted.)

Parameter	Symbol	Conditions	Min Typ Max		Max	Unit
GENERAL CHARACTERISTICS Differential Output Offset Voltage Output Impedance	V _{OOS} Z _{OUT}	$A_{\rm VD} = 2$		5 0.1	50	mV Ω
SHUTDOWN INPUT Input Voltage High Input Voltage Low	V _{IH} V _{IL}	I _{SY} = < 100 μA	1.7		1	v v
POWER SUPPLY Supply Current Supply Current, Shutdown Mode	I _{SY} I _{SD}	$V_{O1} = V_{O2} = 1.65 V$ Pin 1 = V_{DD} , See TPC 29		5.2 100		mA nA
AUDIO PERFORMANCE Total Harmonic Distortion	THD + N	$P = 0.35$ W into 8 Ω , f = 1 kHz	0.1		%	

ELECTRICAL CHARACTERISTICS ($V_s = 2.7 V$, $T_A = 25^{\circ}C$, $R_L = 8 \Omega$, $C_B = 0.1 \mu$ F, $V_{CM} = V_s/2$, unless otherwise noted.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
GENERAL CHARACTERISTICS Differential Output Offset Voltage Output Impedance	V _{OOS} Z _{OUT}	$A_{VD} = 2$		5 0.1	50	mV Ω
SHUTDOWN CONTROL Input Voltage High Input Voltage Low	V _{IH} V _{IL}	$I_{SY} = < 100 \ \mu A$ $I_{SY} = Normal$	1.5		0.8	v v
POWER SUPPLY Supply Current Supply Current, Shutdown Mode	I _{SY} I _{SD}	$V_{O1} = V_{O2} = 1.35 V$ Pin 1 = V_{DD} , See TPC 29		4.2 100		mA nA
AUDIO PERFORMANCE Total Harmonic Distortion	THD + N	P = 0.25 W into 8 Ω, f = 1 kHz		0.1		%

Specifications subject to change without notice

SSM2211

ABSOLUTE MAXIMUM RATINGS^{1, 2}

Supply Voltage
Input Voltage V _{DD}
Common Mode Input Voltage V _{DD}
ESD Susceptibility 2000 V
Storage Temperature Range65°C to +150°C
Operating Temperature Range20°C to +85°C
Junction Temperature Range65°C to +165°C
Lead Temperature Range (Soldering, 60 sec) 300°C

NOTES

¹Absolute maximum ratings apply at 25°C, unless otherwise noted.

²Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Type	$\theta_{JA}{}^1$	θ _{JC}	Units
8-Lead LFCSP (CP) ² 8-Lead SOIC (S)	50 98	43	°C/W °C/W
8-Lead PDIP $(P)^3$	103	43	°C/W

NOTES

 1 For the SOIC package, θ_{JA} is measured with the device soldered to a 4-layer printed circuit board.

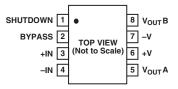
 $^{2}\bar{P}or$ the LFCSP package, θ_{JA} is measured with exposed lead frame soldered to the printed circuit board.

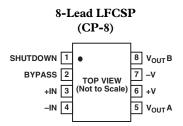
³Special order only.

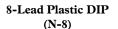


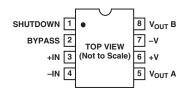
8-Lead SOIC

(SO-8)









ORDERING GUIDE

Model	Temperature Range	Package Description	Package Options	Brand
SSM2211CP-Reel SSM2211S SSM2211S-Reel SSM2211S-Reel7 SSM2211P	-20°C to +85°C -20°C to +85°C -20°C to +85°C -20°C to +85°C -20°C to +85°C -20°C to +85°C	8-Lead LFCSP 8-Lead SOIC 8-Lead SOIC 8-Lead SOIC 8-Lead PDIP	CP-8 SO-8 SO-8 SO-8 N-8*	B5A

*Special order only.

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the SSM2211 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

